MOTOROLA SEMICONDUCTOR TECHNICAL DATA

MJ12002

Designers Data Sheet

HORIZONTAL DEFLECTION TRANSISTOR

... specifically designed for use in large screen color deflection circuits.

- Collector-Emitter Voltage VCEX = 1500 Volts
- Glassivated Base-Collector Junction
- Forward Bias Safe Operating Area @ 50 μs = 15 A, 300 V
- Switching Times with Inductive Loads $t_f = 0.65 \,\mu s \,(Typ) \,@ \,I_C = 2.0 \,A$

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCEO	750	Vdc
Collector-Emitter Voltage	VCEX	1500	Vdc
Emitter-Base Voltage	VEBO	5.0	Vdc
Collector Current — Continuous	lc	2.5	Adc
Base Current Continuous	IВ	2.0	Adc
Emitter Current - Continuous	1E	4.5	Adc
Total Power Dissipation @ T _C = 25°C @ T _C = 100°C Derate above 25°C	PD	75 30 0.6	Watts Watts W/ ^O C
Operating and Storage Junction Temperature Range	TJ, T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

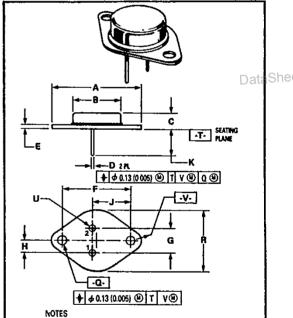
Characteristic	Symbol	Max	Unit	
Thermal Resistance, Junction to Case	R _θ JC	1.67	oC/W	
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	275	°C	

2.5 AMPERE **NPN SILICON POWER TRANSISTOR**

1500 VOLTS 75 WATTS

Designer's Data for "Worst Case" Conditions

The Designers Data Sheet permits the design of most circuits entirely from the information presented. Limit data - representing device characteristics boundaries – are given to facilitate "worst case" design.



- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION-INCH.
- 3. ALL RULES AND NOTES ASSOCIATED WITH

	neperenced to-zuraa outline shall apply.								
1		MILLIA	HETERS	RNC	HE\$				
	DIM	MIN	MAX	MIN	MAX	STYLE 1:			
	A		39.37	ı	1 550	PIN 1. BASE			
	В	1	21 08	-	0 830	2. EMITTER			

CORN 1		TIME 1	1000	
	39.37	-	1 550	
_	21 08		0 830	
635	8.25	0.250	0 325	
0.97	1 09	0 038	0 043	
140	1.77	0 055	0 070	
30.15	BSC	1.187 8SC		
10.92 BSC		0 430 8SC		
5.46	BSC	0.215 BSC		
16.89 BSC 0 665 BSC		8SC		
11.18	12.19	0.440	0 480	
3.84	4.19	0 151	0 165_	
_	26.67		1 050	
4.83	5.33	0 190	0 210	
3 84	4.19	0.151	0 165	
		- 39.37 - 21.08 635 8.25 0.97 1.09 140 1.77 30.15 BSC 10.97 BSC 10.97 BSC 16.83 BSC 11.18 12.19 384 4.19 - 26.67 4.83 5.33	- 39.37 21.08 535 8.25 0.250 0.97 1.09 0.038 1.40 1.77 0.055 30.15 BSC 1.187 10.92 BSC 0.430 5.46 BSC 0.215 16.83 BSC 0.665 11.18 12.19 0.440 3.84 4.19 0.151 - 26.67 4.83 5.33 0.190	

CASE COLLECTOR

CASE 1-06 TO-204AA (TO-3)

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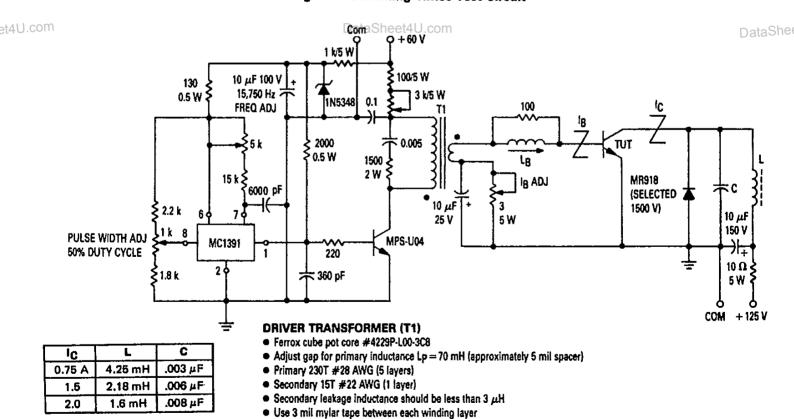
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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS (1)					
Collector-Emitter Sustaining Voltage (IC = 50 mAdc, IB = 0)	VCEO(sus)	750	-	_	Vdc
Collector Cutoff Current (VCE = 1500 Vdc, VBE = 0)	CES	_	_	1.0	mAde
Emitter Cutoff Current (VBE = 5.0 Vdc, IC = 0)	IEBO		_	0.1	mAde
ON CHARACTERISTICS (1)					
Collector-Emitter Saturation Voltage (IC = 2.0 Adc, HB = 1.8 Adc)	V _{CE(sat)}	_	-	5,0	Vdc
Base-Emitter Saturation Voltage (IC = 2.0 Adc, IB = 1.8 Adc)	V _{BE(sat)}		_	1.5	Vdc
Second Breakdown Collector Current with Base-Forward Biased	Is/B		See Figure 14		_
DYNAMIC CHARACTERISTICS					
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	C _{ob}	<u> </u>	50	-	pF
Current Gain — Bandwidth Product (1) (IC = 0.1 Adc, VCE = 5.0 Vdc, f _{test} = 1.0 MHz)	fΤ	-	4.0	-	MHz
SWITCHING CHARACTERISTICS					
Falt Time (IC = 2.0 Adc, IB1 = 1.0 Adc, LB = 12 µH, See Figure 1)	tf	_	0.65	1.0	μs

⁽¹⁾ Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle = 2%.

Figure 1. Switching Times Test Circuit



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BASE DRIVE: The Key to Performance

By now, the concept of controlling the shape of the turn-off base current is widely accepted and applied in horizontal deflection design. The problem stems from the fact that good saturation of the output device, prior to turn-off, must be assured. This is accomplished by providing more than enough IB1 to satisfy the lowest gain output device her at the end of scan ICM. Worst case component variations and maximum high voltage loading must also be taken into account.

If the base of the output transistor is driven by a very low impedance source, the turn-off base current will reverse very quickly as shown in Figure 2. This results in rapid, but only partial, collector turn-off, because excess carriers become trapped in the high resistivity collector and the transistor is still conductive. This is a high dissipation mode, since the collector voltage is rising very rapidly. The problem is overcome by adding inductance to the base circuit to slow the base current reversal as shown in Figure 3, thus allowing excess carrier recombination in the collector to occur while the base current is still flowing.

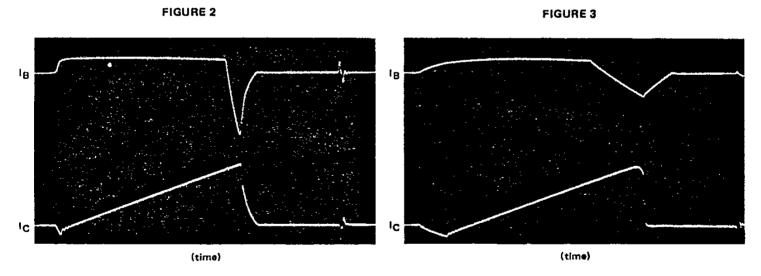
Choosing the right LB is usually done empirically, since the equivalent circuit is complex, and since there are several important variables (ICM, IB1, and hFE at ICM). One method is to plot fall time as a function of LB, at the desired conditions, for several devices within the hFE specification. A more informative method is to plot power dissipation versus IB1 for a range of values of LB as shown

in Figures 4 and 5. This shows the parameter that really matters, dissipation, whether caused by switching or by saturation. The negative slope of these curves at the left (low IB1) is caused by saturation losses. The positive slope portion at higher IB1, and low values of LB is due to switching losses as described above. Note that for very low LB a very narrow optimum is obtained. This occurs when IB1 hFE = ICM, and therefore would be acceptable only for the "typical" device with constant ICM. As LB is increased, the curves become broader and flatter above the IB1 hFE = ICM point as the turn-off "tails" are brought under control. Eventually, if LB is raised too far, the dissipation all across the curve will rise, due to poor initiation of switching rather than tailing. Plotting this type of curve family for devices of different her, essentially moves the curves to the left or right according to the relation IB1 hFE = constant. It then becomes obvious that, for a specified ICM, an LB can be chosen which will give low dissipation over a range of hee and/or IB1. The only remaining decision is to pick IB1 high enough to accommodate the lowest hFE part specified. Figure 8 gives values recommended for LB and IB1 for this device over a wide range of ICM. These values were chosen from a large number of curves like Figure 4 and Figure 5. Neither LB nor IB1 are absolutely critical, as can be seen from the examples shown, and values of Figure 8 are provided for guidance only.

TEST CIRCUIT WAVEFORMS

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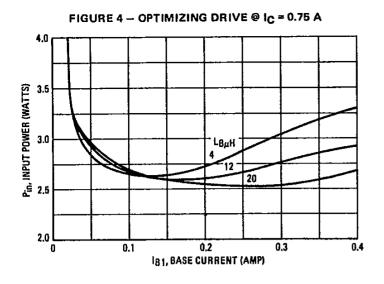


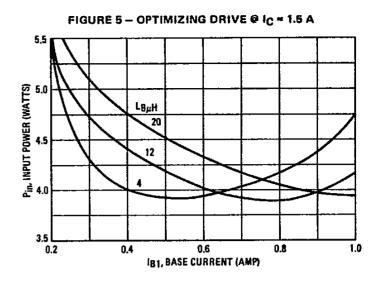
TEST CIRCUIT OPTIMIZATION

The test circuit may be used to evaluate devices in the conventional manner, i.e., to measure fall time, storage time, and saturation voltage. However, this circuit was designed to evaluate devices by a simple criterion, power supply input. Excessive power input can be caused by a variety of problems, but it is the dissipation in the transistor that is of fundamental importance.

Once the required transistor operating current is determined, fixed circuit values may be selected from the table. Factory testing is performed by reading the current meter only, since the input power is proportional to current. No adjustment of the test apparatus is required.

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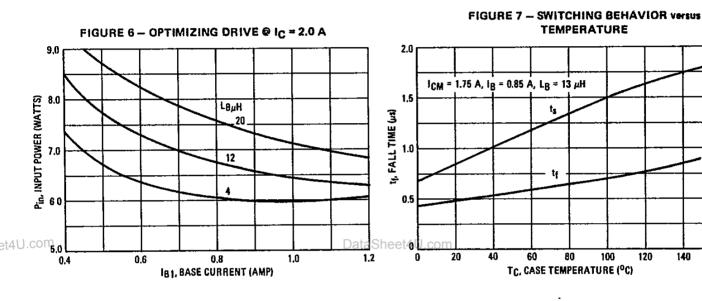


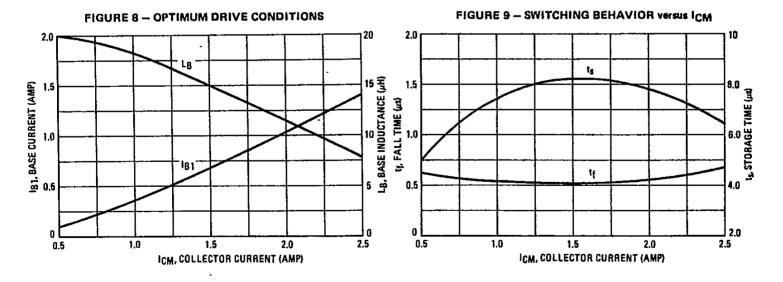
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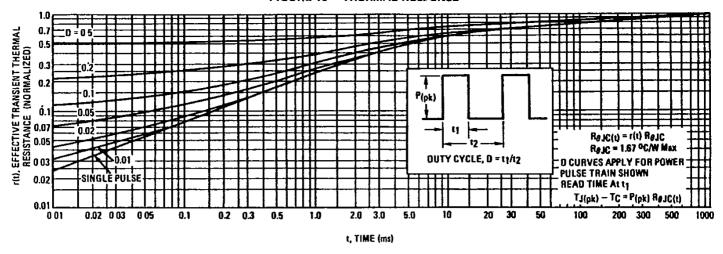
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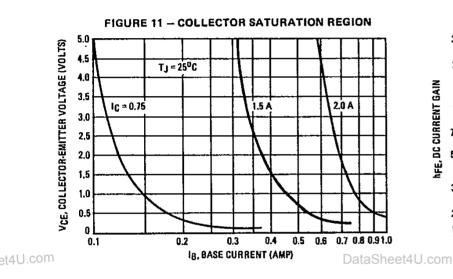


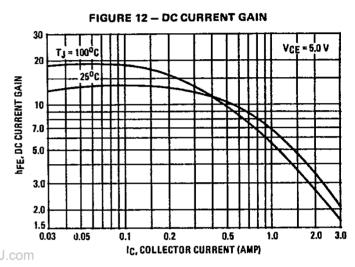


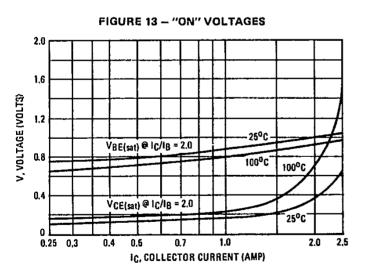
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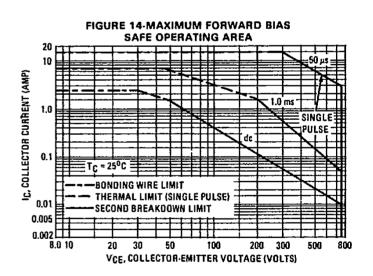
FIGURE 10 - THERMAL RESPONSE











NOTE:

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The 50 μ s SB curve is beyond the thermal limits of this part. However, the parts will survive a transient that remains within these SB limits without failing.

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